

TE Internal #: 2-2355626-1 DIMM Sockets, Double Data Rate (DDR) 5, Board-to-Component, 288 Position, Surface Mount Mount, Vertical Module Orientation View on TE.com >



Connectors > Socket Connectors > Memory Sockets > DIMM Sockets



DRAM Type: Double Data Rate (DDR) 5

Connector System: Board-to-Component

Number of Positions: 288

PCB Mounting Style: Surface Mount

Module Orientation: Vertical

# Features

### **Product Type Features**

DRAM Type	Double Data Rate (DDR) 5			
Connector System	Board-to-Component			
Connector & Contact Terminates To	Printed Circuit Board			
Configuration Features				
Number of Bays	2			
Number of Keys	1			
Number of Rows	2			
Number of Positions	288			
Module Orientation	Vertical			
Electrical Characteristics				
DRAM Voltage	1.1 V			
Body Features				
PCB Retention Feature Material	Stainless Steel			
Ejector Material Color	Black			
Ejector Material	High Temperature Nylon			

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Latch Color	Black
Ejector Location	Both Ends
Latch Material	High Temperature Nylon
Module Key Type	DRAM
Connector Profile	Standard
Ejector Type	Rotary
Contact Features	
Memory Socket Type	Memory Card
Socket Style	DIMM
PCB Contact Termination Area Plating Material Thickness	3 μm[120 μin]
Contact Mating Area Plating Material Thickness	.76 μm[30 μin]
Contact Mating Area Plating Material	Gold
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Copper Alloy
Contact Current Rating (Max)	1.5 A

### **Termination Features**

Insertion Style	Direct Insert		
Termination Post & Tail Length	.89 mm[.035 in]		
Mechanical Attachment			
Mount Angle	Vertical		
PCB Mount Alignment Type	None		
Mating Alignment Type	1 Key		
Mating Alignment	With		
PCB Mount Retention Type	Tab		
PCB Mounting Style	Surface Mount		
Connector Mounting Type	Board Mount		
Housing Features			
Housing Material	High Temperature Nylon		
Housing Color	Black		
Centerline (Pitch)	.85 mm[.033 in]		
Dimensions			

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Profile Height from PCB	21.3 mm[.083 in]
Row-to-Row Spacing	3 mm[.118 in]
Jsage Conditions	
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
Operation/Application	
Circuit Application	High Speed Data
ndustry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	640
Packaging Method	Box & Tray

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold

EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Solder Process Capability

Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

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# **Compatible Parts**



# Customers Also Bought



TE Part #2339207-2	TE Part #7-2308107-2	TE Part #7-2308107-4	TE Part #2-2434993-1	
56 POSITION SLIVER ORTHOGONAL	DDR4 DIMM 288 PIN TH TYPE	DDR4 DIMM 288 PIN TH TYPE	ASSY STRADDLE MOUNT 168P 093	
EDSFF 1*1			SLIVER 2.0	

### Documents

Product Drawings DDR5 DIMM BLACK HSG AND BLACK LATCH

English

#### **CAD** Files

Customer View Model ENG\_CVM\_CVM\_2-2355626-1\_A.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2-2355626-1\_A.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_2-2355626-1\_A.3d\_stp.zip

English

3D PDF

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3D

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

**Application Specification** 

English

Product Environmental Compliance

**Product Compliance** 

English

**Product Compliance** 

English